

MEMS audio sensor omnidirectional digital microphone

Datasheet - production data

Features

- Single supply voltage
- Low power consumption
- 120 dBSPL acoustic overload point
- Omnidirectional sensitivity
- PDM single-bit output with option for stereo configuration
- HLGA package (SMD-compliant)
- ECOPACK®, RoHS, and "Green" compliant

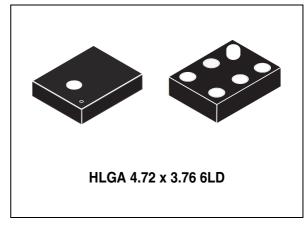
Applications

- Mobile terminals
- Laptop and notebook computers
- Portable media players
- VolP
- Speech recognition
- A/V eLearning devices
- Gaming and virtual reality input devices
- Digital still and video cameras
- Antitheft systems

Description

The MP45DT02 is a compact, low-power, topport, omnidirectional, digital MEMS microphone. The MP45DT02 is built with a sensing element and an IC interface with stereo capability.

The sensing element, capable of detecting acoustic waves, is manufactured using a



specialized silicon micromachining process to produce audio sensors.

The IC interface is manufactured using a CMOS process that allows designing a dedicated circuit able to provide a digital signal externally in PDM format.

The MP45DT02 has an acoustic overload point of 120 dBSPL with a best on the market 61 dB signal-to-noise ratio and -26 dB sensitivity.

The MP45DT02 is available in an SMD-compliant package and is guaranteed to operate over an extended temperature range from -30 °C to +85 °C.

The MP45DT02's digital output and package size (1.25 mm thick) make this device the best solution for laptop and portable computing applications.

Table 1. Device summary

Order code	Temperature range [°C]	Package	Packing
MP45DT02	-30 to +85	HLGA 4.72 x 3.76 6LD	Tray
MP45DT02TR	-30 to +85	HLGA 4.72 x 3.76 6LD	Tape and reel

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MP45DT02 Pin description

1 Pin description

Figure 1. Pin connections

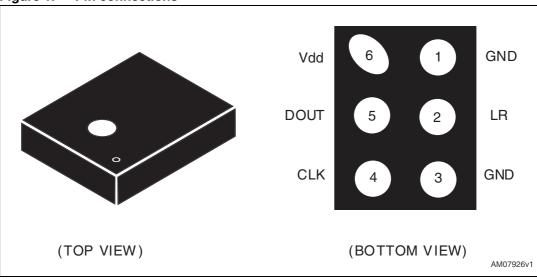


Table 2. Pin description

Pin #	Pin name	Function
1	GND	0 V supply
2	LR	Left/right channel selection; MIC1 LR is connected to GND or Vdd and MIC2 LR is connected to Vdd or GND (see <i>Figure 5</i>)
3	GND	0 V supply
4	CLK	Synchronization input clock
5	DOUT	Left/right PDM data output
6	Vdd	Power supply

2 Acoustic and electrical specifications

2.1 Acoustic and electrical characteristics

The values listed in the table below are specified for Vdd = 1.8 V, Clock = 2.4 MHz, T = 25 °C, unless otherwise noted.

Table 3. Acoustic and electrical characteristics

Symbol	Parameter	Test condition	Min.	Typ. ⁽¹⁾	Max.	Unit
Vdd	Supply voltage		1.64	1.8	3.6	V
Idd	Current consumption in normal mode	No load on data line		0.65		mA
IddPdn	Current consumption in power-down mode ⁽²⁾			20		μΑ
Scc	Short-circuit current		1		10	mA
AOP	Acoustic overload point			120		dBSPL
So	Sensitivity		-29	-26	-23	dBFS
SNR	Signal-to-noise ratio	A-weighted @1 kHz, 1 Pa		61		dB
PSR	Power supply rejection	Guaranteed by design ⁽³⁾		-70		dBFS
Clock	Input clock frequency ⁽⁴⁾		1	2.4	3.25	MHz
TWK	Wake-up time ⁽⁵⁾	Guaranteed by design			10	ms
Тор	Operating temperature range		-30		+85	°C
V _{IOL}	Low level logic input/output voltage	I _{out} = 1 mA	-0.3		0.35xVdd	V
V _{IOH}	High level logic input/output voltage	I _{out} = 1 mA	0.65xVdd		Vdd+0.3	V

^{1.} Typical specifications are not guaranteed.

Table 4. Distortion specifications

Parameter	Test condition	Value
Distortion	100 dBSPL (50 Hz - 4 kHz)	< 1% THD + N
Distortion	115 dBSPL (1 kHz)	< 5% THD + N

^{2.} Input clock in static mode.

^{3.} Test signal: 217 Hz square wave, 100 mVpp on Vdd pin.

^{4.} Duty cycle: min = 40% max = 60%.

^{5.} Time from the first clock edge to valid output data.

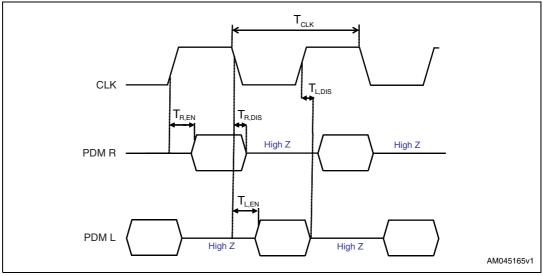
2.2 Timing characteristics

Table 5. Timing characteristics

Parameter	Description	Min	Max	Unit
f _{CLK}	Clock frequency for normal mode	1	3.25	MHz
f _{PD}	Clock frequency for power-down mode		0.23	MHz
T _{CLK}	Clock period for normal mode	308	1000	ns
$T_{R,EN}$	Data enabled on DATA line, L/R pin = 1	30 ⁽¹⁾		ns
$T_{R,DIS}$	Data disabled on DATA line, L/R pin = 1		16 ⁽¹⁾	ns
T _{L,EN}	Data enabled on DATA line, L/R pin = 0	30 ⁽¹⁾		ns
T _{L,DIS}	Data disabled on DATA line, L/R pin = 0		16 ⁽¹⁾	ns

^{1.} From design simulations

Figure 2. Timing waveforms



2.3 Frequency response

Figure 3. Typical frequency response normalized at 1 kHz

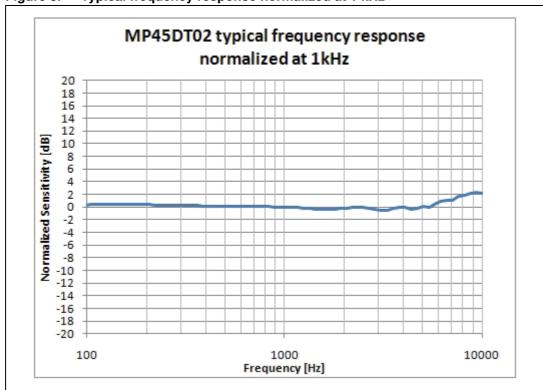


Table 6. Frequency response mask for digital microphones

Frequency / Hz ⁽¹⁾	Lower limit	Upper limit	Unit
20100	-5	+5	dBr 1kHz
1008000	-2	+2	dBr 1kHz
800010000	-5	+5	dBr 1kHz

^{1.} At T = 20 °C and acoustic stimulus = 1 Pa (94 dB SPL)

3 Absolute maximum ratings

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 7. Absolute maximum ratings

Symbol	Ratings	Maximum value	Unit
Vdd	Supply voltage	-0.3 to 6	V
Vin	Input voltage on any control pin	-0.3 to Vdd +0.3	V
T _{STG}	Storage temperature range	-40 to +125	°C
ESD	Electrostatic discharge protection	2 (HBM)	kV



This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.



This device is ESD-sensitive, improper handling can cause permanent damage to the part.

Functionality MP45DT02

4 Functionality

4.1 L/R channel selection

The L/R digital pad lets the user select the DOUT signal pattern as explained in *Table 8*. The L/R pin must be connected to Vdd or GND.

Table 8. L/R channel selection

L/R	CLK low	CLK high
GND	Data valid	High impedence
Vdd	High impedence	Data valid

5 Application recommendations

Figure 4. MP45DT02 electrical connections

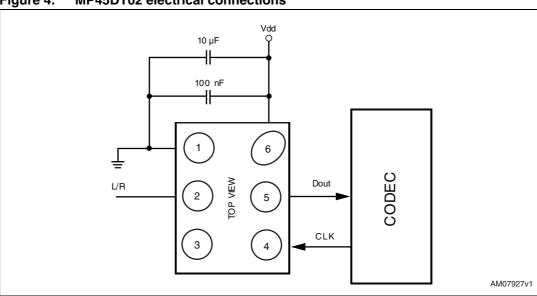
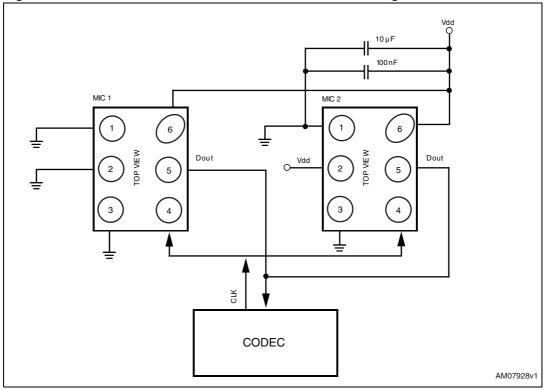


Figure 5. MP45DT02 electrical connections for stereo configuration



Power supply decoupling capacitors (100 nF ceramic, 10 μ F ceramic) should be placed as near as possible to pin 6 of the device (common design practice).

The L/R pin must be connected to Vdd or GND (refer to Table 8).

6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Soldering information

The HLGA (4.72 x 3.76 x 1.25) mm package is also compliant with the RoHS and "Green" standards and is qualified for soldering heat resistance according to JEDEC J-STD-020.

Landing pattern and soldering recommendations are available at www.st.com.

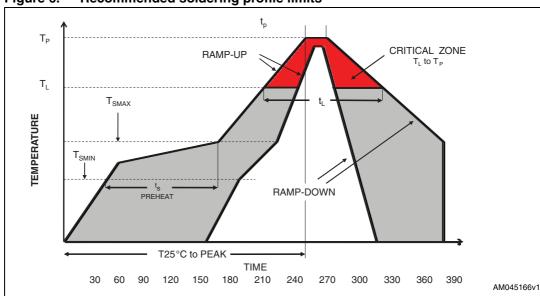


Figure 6. Recommended soldering profile limits

Table 9. Recommended soldering profile limits

Description	Parameter	Pb free
Average ramp rate	T_L to T_P	3 °C/sec max
Preheat		
Minimum temperature	T _{SMIN}	150 °C
Maximum temperature	T _{SMAX}	200 °C
Time (T _{SMIN} to T _{SMAX})	t _S	60 sec to 120 sec
Ramp-up rate	T_{SMAX} to T_{L}	
Time maintained above liquidous temperature	t∟	60 sec to 150 sec
Liquidous temperature	T_L	217 °C
Peak temperature	T _P	260 °C max
Time within 5 °C of actual peak temperature		20 sec to 40 sec
Ramp-down rate		6 °C/sec max
Time 25 °C (t25 °C) to peak temperature		8 minutes max

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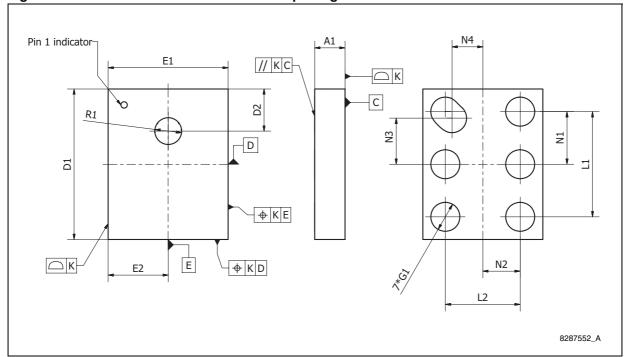


Figure 7. HLGA 4.72 mm x 3.76 mm 6-lead package outline

Table 10. HLGA 4.72 mm x 3.76 mm 6-lead package dimensions

Symbol	mm		
	Min	Тур	Max
A1	1.125	1.250	1.375
D1	4.670	4.720	4.770
D2		1.320	
R1	0.750	0.840	0.930
E1	3.710	3.760	3.810
E2		1.880	
L1	3.200	3.300	3.400
L2	2.250	2.350	2.450
N1	1.550	1.650	1.750
N2	1.075	1.175	1.275
N3	1.350	1.450	1.550
N4	0.865	0.965	1.065
G1	0.810	0.910	1.010
К		0.050	

Revision history MP45DT02

7 Revision history

Table 11. Document revision history

Date	Revision	Changes
28-Mar-2011	1	Initial release
21-Oct-2011	2	Added max. peak temperature T _P to <i>Table 9</i> Added min. and max. sensitivity So to <i>Table 3</i>
01-Mar-2012	3	Document status promoted from preliminary to production data Updated SNR to 61 dB (<i>Description</i> and <i>Table 3</i>)
07-May-2012	4	Added V _{IOL} , V _{IOH} to <i>Table 3: Acoustic and electrical characteristics</i>

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